

## General Description

The AO4815 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. The device is ESD protected.

## Features

$V_{DS}$  (V) = -30V

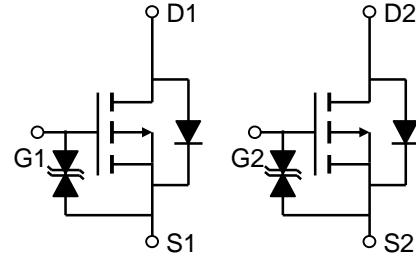
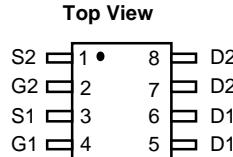
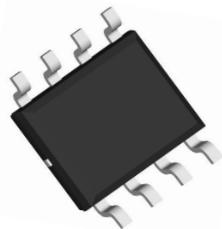
$I_D$  = -8A ( $V_{GS}$  = -20V)

$R_{DS(ON)} < 18m\Omega$  ( $V_{GS}$  = -20V)

$R_{DS(ON)} < 20m\Omega$  ( $V_{GS}$  = -10V)



SOIC-8



### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 25$	V
Continuous Drain Current <sup>A</sup>	$I_D$	-8	A
$T_A=70^\circ C$		-6.9	
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	-40	
Power Dissipation <sup>A</sup>	$P_D$	2	W
$T_A=70^\circ C$		1.44	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	50	62.5	°C/W
Steady-State		73	110	°C/W
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	31	40	°C/W

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-30			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=-24\text{V}, V_{GS}=0\text{V}$			-1	$\mu\text{A}$
		$T_J=55^\circ\text{C}$			-5	
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm25\text{V}$			$\pm 1$	$\mu\text{A}$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-1	-2.8	-3	V
$I_{\text{D(ON)}}$	On state drain current	$V_{GS}=-10\text{V}, V_{DS}=-5\text{V}$	-40			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=-20\text{V}, I_D=-8\text{A}$		14.1	18	$\text{m}\Omega$
		$T_J=125^\circ\text{C}$		19	24	
		$V_{GS}=-10\text{V}, I_D=-8\text{A}$		16.2	20	$\text{m}\Omega$
$R_g$	Forward Transconductance	$V_{GS}=-4.5\text{V}, I_D=-5\text{A}$		37		$\text{m}\Omega$
$V_{\text{SD}}$	Diode Forward Voltage	$I_S=-1\text{A}, V_{GS}=0\text{V}$			-1	V
$I_s$	Maximum Body-Diode Continuous Current				-2.6	A
<b>DYNAMIC PARAMETERS</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$		2330	2900	pF
$C_{\text{oss}}$	Output Capacitance			480		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			320		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		6.8	10	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, I_D=-8\text{A}$		41	52	nC
$Q_{\text{gs}}$	Gate Source Charge			10		nC
$Q_{\text{gd}}$	Gate Drain Charge			12		nC
$t_{\text{D(on)}}$	Turn-On DelayTime	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=1.8\Omega, R_{\text{GEN}}=3\Omega$		13		ns
$t_r$	Turn-On Rise Time			12		ns
$t_{\text{D(off)}}$	Turn-Off DelayTime			51		ns
$t_f$	Turn-Off Fall Time			30.5		ns
$t_{\text{rr}}$	Body Diode Reverse Recovery Time		$I_F=-8\text{A}, dI/dt=100\text{A}/\mu\text{s}$	28	35	ns
$Q_{\text{rr}}$	Body Diode Reverse Recovery Charge	$I_F=-8\text{A}, dI/dt=100\text{A}/\mu\text{s}$		20.5		nC

 A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .

 The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

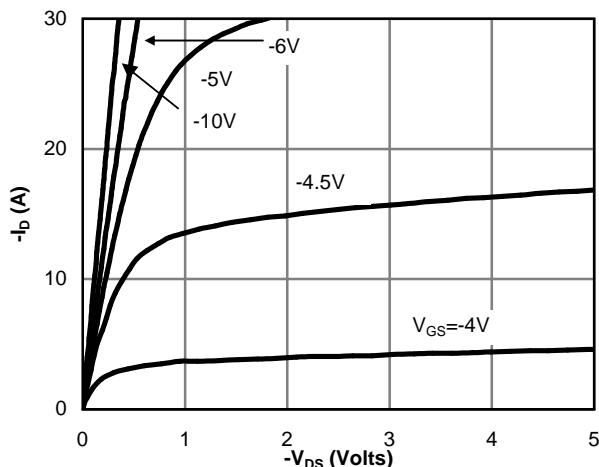
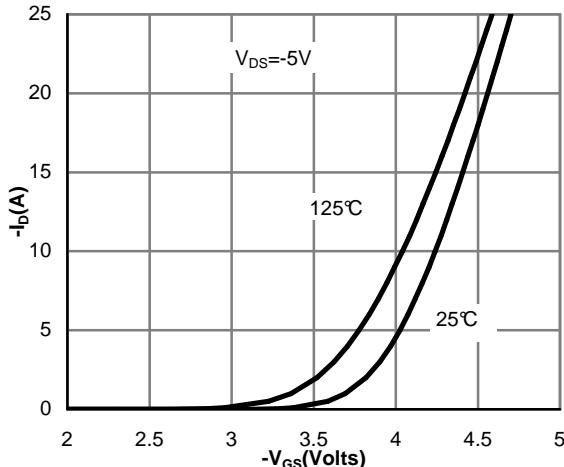
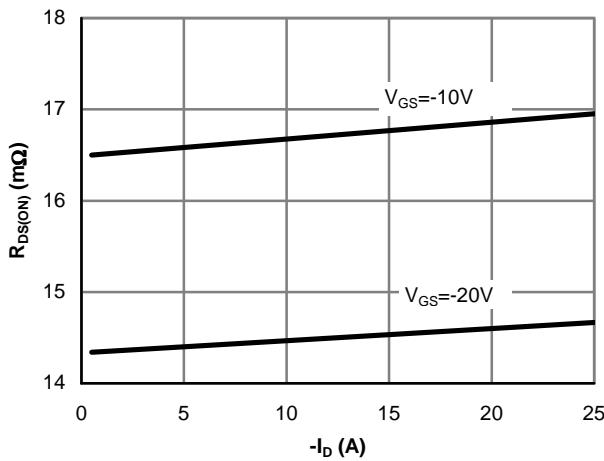
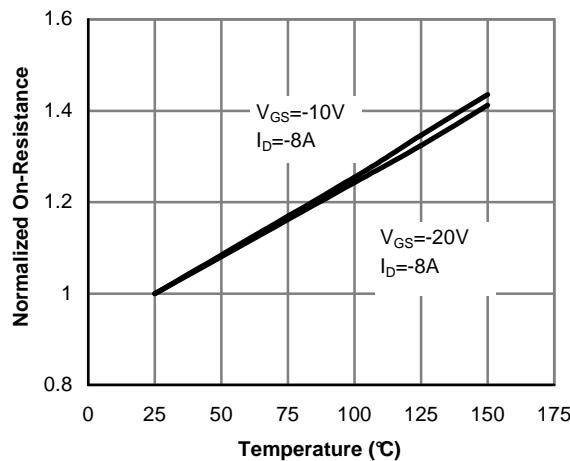
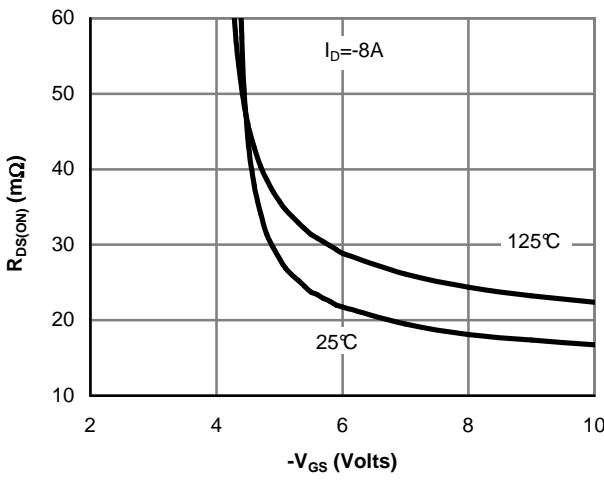
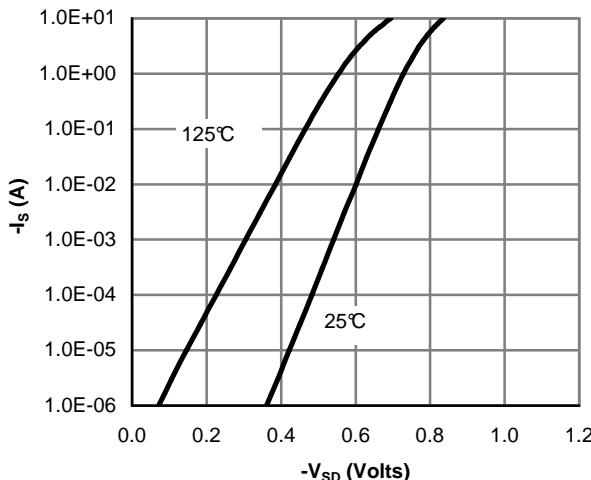
B: Repetitive rating, pulse width limited by junction temperature.

 C. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

 D. The static characteristics in Figures 1 to 6 are obtained using <300  $\mu\text{s}$  pulses, duty cycle 0.5% max.

 E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

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**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Figure 1: On-Region Characteristics**

**Figure 2: Transfer Characteristics**

**Figure 3: On-Resistance vs. Drain Current and Gate Voltage**

**Figure 4: On-Resistance vs. Junction Temperature**

**Figure 5: On-Resistance vs. Gate-Source Voltage**

**Figure 6: Body-Diode Characteristics**



**freescale**

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**AO4815**

**30V Dual P-Channel MOSFET**

### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

